

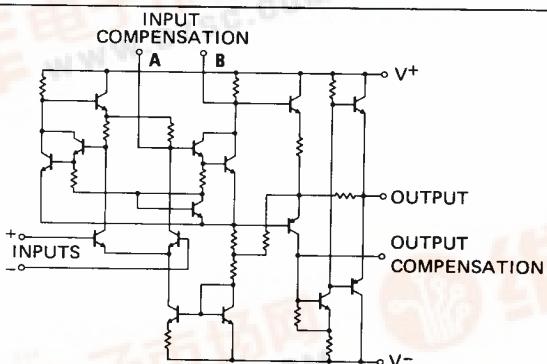
## GENERAL DESCRIPTION

The RM709 and RC709 are monolithic, high gain DC operational amplifiers fabricated on a single silicon chip by the planar process.

These devices are designed for use in operational amplifier signal processing, low level instrumentation, control systems and for the generation of special linear and non-linear transfer functions.

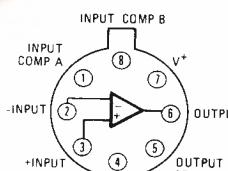
The RM709 operates over the full military temperature range from  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ . The RC709 is the commercial device intended to operate over a temperature range of  $0^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$ .

## SCHEMATIC DIAGRAM



## CONNECTION INFORMATION

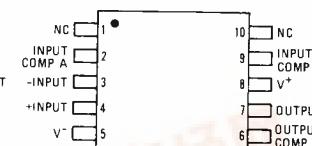
TE (TO-99)  
Metal Can Package  
(Top View)



NOTE: Pin 4 connected to case.

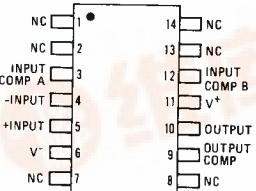
Order Part Nos.:  
RM709T, RC709T

CQ  
Flat Package  
(Top View)



Order Part Nos.:  
RM709CQ

DC  
Dual In-line Package  
(Top View)



NOTE: Pin 7 connected to bottom of package.

Order Part Nos.:  
RM709DC, RC709DC

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage	$\pm 18V$	$\pm 18V$	Output Short-Circuit Duration ( $T_A = 25^\circ C$ )	5 sec
Differential Input Voltage	$\pm 5V$	$\pm 5V$	Storage Temperature Range	$-65^\circ C$ to $+150^\circ C$
Input Voltage	$\pm 10V$	$\pm 10V$	Operating Temperature Range	$-55^\circ C$ to $+125^\circ C$
Power Dissipation (Note)			RM709/709A	$0^\circ C$ to $+70^\circ C$
Dual In-line Package	300mW	300mW	RC709	$0^\circ C$ to $+70^\circ C$
TO-5 Package	300mW	300mW	Lead Temperature (Soldering, 60s)	300°C
Flat Package	250mW	250mW		

ELECTRICAL CHARACTERISTICS ( $|9 \leq V_S \leq \pm 15V, T_A = 25^\circ C$  unless otherwise specified)

PARAMETER	CONDITIONS	RM709			RC709			UNITS
		MIN	Typ	MAX	MIN	Typ	MAX	
Input Offset Voltage	$R_S \leq 10k\Omega$	1.0	3.0		2.0	7.5		mV
Input Offset Current		25	100		100	500		nA
Input Bias Current		180	300		300	1500		nA
Input Resistance		220	400		50	250		kΩ
Output Resistance		150			150			Ω
Supply Current	$V_S = \pm 15V$	2.6	4.0		6.6			mA
Power Consumption	$V_S = \pm 15V$	80	120		80	200		mW
Transient Response	$R_L = 2k\Omega, V_S = \pm 15V, V_{IN} = 20mV$							
Rise Time	$C_1 = 5nF, R_1 = 1.5k, C_2 = 200pF, R_2 = 50\Omega$	0.3	1.0		0.3	1.0		μs
Overshoot	$C_L \leq 100pF$	10	30		10	30		%
Slew Rate	$V_S = \pm 15V, R_L \geq 10k\Omega, A_V = 1$	0.15	0.4		0.4			V/μs
Large Signal Voltage Gain	$V_S = \pm 15V, R_L = 2k, V_{OUT} = \pm 10V$				15	45		kV/V
The following specifications apply for $-55^\circ C \leq T_A \leq +125^\circ C$ for RM; $0^\circ C \leq T_A \leq 70^\circ C$ for RC.								
Large Signal Voltage Gain	$V_S = \pm 15V, R_L \geq 2k, V_{OUT} = \pm 10V$	25	45	70	12			kV/V
Input Offset Voltage	$R_S \leq 10k\Omega$			4.0		10		mV
Input Offset Current	$T_A = \text{max}$	10	100					nA
	$T_A = \text{min}$	50	300		750			
Input Bias Current	$T_A = \text{min}$	400	1000		2000			nA
Average Temperature of Coefficient of Input Offset Voltage	$R_S = 50\Omega, T_A = 25^\circ C$ to $T_A = \text{max}$	1.8	10					
	$R_S = 50\Omega, T_A = 25^\circ C$ to $T_A = \text{min}$	1.8	10					μV/°C
	$R_S = 10k, T_A = 25^\circ C$ to $T_A = \text{max}$	2.0	15					
	$R_S = 10k, T_A = 25^\circ C$ to $T_A = \text{min}$	6.0	15					
Average Temperature Coefficient of Input Offset Current	$T_A = +25^\circ C$ to max							nA/°C
	$T_A = +25^\circ C$ to min							
Input Voltage Range	$V_S = \pm 15V$	$\pm 8.0$	$\pm 10$		$\pm 8.0$	$\pm 10$		V
Output Voltage Swing	$V_S = \pm 15V, R_L \geq 10k\Omega$	$\pm 12$	$\pm 14$		$\pm 12$	$\pm 14$		V
	$V_S = \pm 15V, R_L \geq 2k\Omega$	$\pm 10$	$\pm 13$		$\pm 10$	$\pm 13$		
Input Resistance	$T_A = \text{min}$	50	125		35	125		kΩ
Common Mode Rejection Ratio	$R_S \leq 10k\Omega$	70	90		65	90		dB
Supply Voltage Rejection Ratio	$R_S \leq 10k\Omega$			25	150		25	200
Supply Current	$V_S = \pm 15V, T_A = \text{max}$							mA
	$V_S = \pm 15V, T_A = \text{min}$							
Power Consumption	$V_S = \pm 15V, T_A = \text{max}$							mW
	$V_S = \pm 15V, T_A = \text{min}$							

## NOTE:

Derate linearly the maximum power dissipation of the dual in-line package at  $8.6mW/^\circ C$  for ambient temperature above  $+115^\circ C$ , of the TO-5 package at  $5.6mW/^\circ C$  for ambient temperature above  $+95^\circ C$  and of the flat package at  $5.4mW/^\circ C$  for ambient temperature above  $+103^\circ C$ . For RC709, rating applies for case temperatures to  $+70^\circ C$ .